

DDC144TH

NPN PRE-BIASED SMALL SIGNAL DUAL SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Nominal 47kΩ Built-In Biasing Resistor
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free "Green" Device (Note 3)

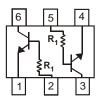
Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.015 grams (Approximate)





Top View



Device Schematic

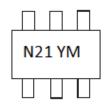
Ordering Information (Notes 3 & 4)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DDC144TH-7-F	Standard	N21	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



N21 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014) M = Month (ex: 9 = September)

Date Code Key

Year	2014		2015	2016		2017	2018		2019	2020		2021
Code	В		С	D		E	F		G	Н		
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	Vcc	50	V
Input Voltage	V _{IN}	-10 to +40	V
Output Current	I _{C(MAX)}	100	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Notes 5 & 6)	P_{D}	150	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	833	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	50		_	V	$I_C = 50\mu A$
Collector-Emitter Breakdown Voltage	BV _{CEO}	50	_		V	$I_C = 1mA$
Emitter-Base Breakdown Voltage	BV_{EBO}	5			V	$I_E = 50\mu A$
Collector Cutoff Current	I _{CBO}	_		0.5	μΑ	$V_{CB} = 50V$
Emitter Cutoff Current	I _{EBO}	_	_	0.5	μA	$V_{EB} = 4V$
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	l	0.3	٧	I _C /I _B = 1mA / 0.1mA
DC Current Transfer Ratio	h _{FE}	100	250	600	_	$I_C = 1mA$, $V_{CE} = 5V$
Input Resistor (R1)	R ₁	32.9	47Ω	61.1	kΩ	_
Gain-Bandwidth Product (Note 7)	f⊤	_	250		MHz	$V_{CE} = 10V$, $I_{E} = -5mA$, $f = 100MHz$

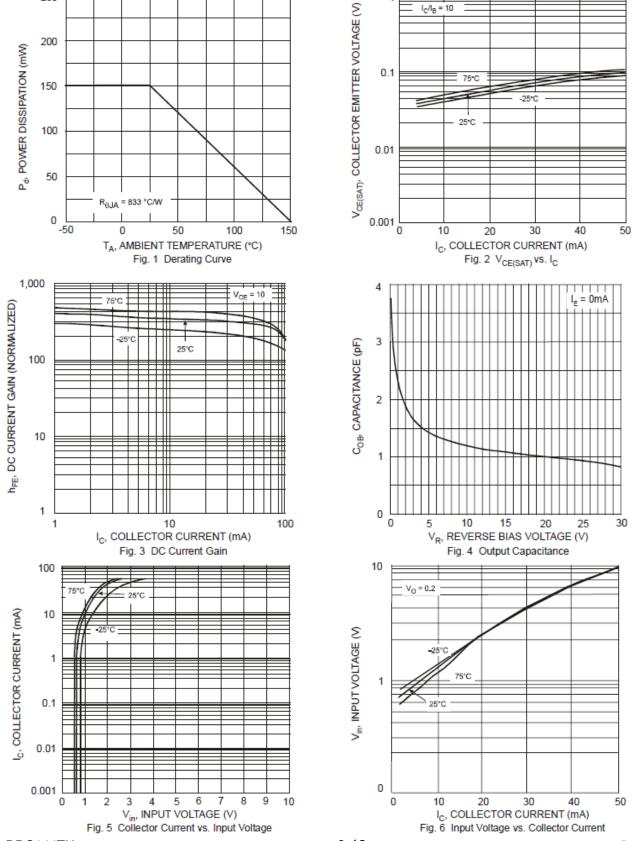
Notes:

- 5. Mounted on FR4 PC Board with minimum recommended pad layout.
- Nounted of Tital C Board with millimited to
 200mW per element must not be exceeded.
 Transistor For Reference Only



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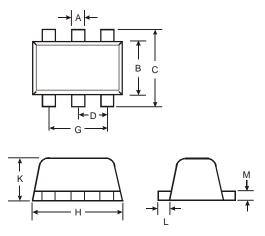
Typical Curves (@T_A = +25°C, unless otherwise specified.)





Package Outline Dimensions

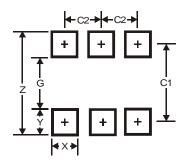
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT563							
Dim	Min	Max	Тур				
Α	0.15	0.30	0.20				
В	1.10	1.25	1.20				
С	1.55	1.70	1.60				
D	-	-	0.50				
G	0.90	1.10	1.00				
Н	1.50	1.70	1.60				
K	0.55	0.60	0.60				
L	0.10	0.30	0.20				
M	0.10	0.18	0.11				
All	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
Z	2.2		
G	1.2		
Х	0.375		
Y	0.5		
C1	1.7		
C2	0.5		



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